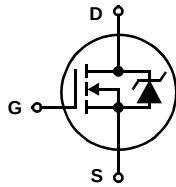
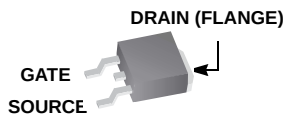


20A, 20V, 0.022 Ohm, N-Channel, Logic Level Power MOSFETs

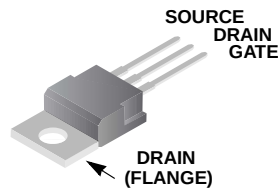
The HUF76013 is an application-specific MOSFET optimized for switching when used as the upper switch in synchronous buck applications. The low gate charge and low input capacitance results in lower driver and lower switching losses thereby increasing the overall system efficiency.

Symbol

Packaging

HUF76013D3S
JEDEC TO-252AA



HUF76013P3
JEDEC TO-220AB


Features

- 20A, 20V
 - $r_{DS(ON)} = 0.022\Omega$, $V_{GS} = 10V$
 - $r_{DS(ON)} = 0.030\Omega$, $V_{GS} = 5V$
- PWM Optimized for Synchronous Buck Applications
- Fast Switching
- Low Gate Charge
 - Q_g Total 14nC (Typ)
- Low Capacitance
 - C_{ISS} 624pF (Typ)
 - C_{RSS} 71pF (Typ)

Ordering Information

PART NUMBER	PACKAGE	BRAND
HUF76013P3	TO-220AB	76013P
HUF76013D3S	TO-252AA	76013D

NOTE: When ordering, use the entire part number. Add the suffix T to obtain the HUF76013D3S in tape and reel, e.g., HUF76013D3ST.

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	PARAMETER	HUF76013P3, HUF76013D3S	UNITS
V_{DSS}	Drain to Source Voltage (Note 1)	20	V
V_{DGR}	Drain to Gate Voltage ($R_{GS} = 20k\Omega$) (Note 1)	20	V
V_{GS}	Gate to Source Voltage	± 16	V
I_D	Drain Current		
I_D	Continuous ($T_C = 25^\circ\text{C}$, $V_{GS} = 10V$) (Figure 2)	20	A
I_D	Continuous ($T_C = 100^\circ\text{C}$, $V_{GS} = 5V$)	20	A
I_{DM}	Pulsed Drain Current	Figure 4	A
P_D	Power Dissipation	50	W
	Derate Above 25°C	0.4	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature	-55 to 150	$^\circ\text{C}$
T_L	Maximum Temperature for Soldering	300	$^\circ\text{C}$
T_{pkg}	Leads at 0.063in (1.6mm) from Case for 10s Package Body for 10s, See Techbrief TB334	260	$^\circ\text{C}$
THERMAL SPECIFICATIONS			
$R_{\theta JC}$	Thermal Resistance Junction to Case, TO-220, TO-252	2.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-220	62	$^\circ\text{C/W}$
	Thermal Resistance Junction to Ambient TO-252	100	$^\circ\text{C/W}$

NOTE:

1. $T_J = 25^\circ\text{C}$ to 125°C .

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

HUF76013P3, HUF76013D3S

Electrical Specifications $T_C = 25^{\circ}\text{C}$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
OFF STATE SPECIFICATIONS							
Drain to Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V (Figure 11)	20	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20V, V _{GS} = 0V	-	-	1	μA	
		V _{DS} = 20V, V _{GS} = 0V, T _C = 150 ⁰ C	-	-	250	μA	
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±16V	-	-	±100	nA	
ON STATE SPECIFICATIONS							
Gate to Source Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250μA (Figure 10)	1	-	3	V	
Drain to Source ON Resistance	r _{DS(ON)}	I _D = 20A, V _{GS} = 10V (Figures 8, 9)	-	0.018	0.022	Ω	
		I _D = 20A, V _{GS} = 5V (Figure 8)	-	0.025	0.030	Ω	
SWITCHING SPECIFICATIONS (V _{GS} = 5V)							
Turn-On Time	t _{ON}	V _{DD} = 10V, I _D = 20A V _{GS} = 5V, R _{GS} = 19Ω (Figures 14, 18, 19)	-	-	197	ns	
Turn-On Delay Time	t _{d(ON)}		-	11	-	ns	
Rise Time	t _r		-	120	-	ns	
Turn-Off Delay Time	t _{d(OFF)}		-	19	-	ns	
Fall Time	t _f		-	30	-	ns	
Turn-Off Time	t _{OFF}		-	-	72	ns	
SWITCHING SPECIFICATIONS (V _{GS} = 10V)							
Turn-On Time	t _{ON}	V _{DD} = 10V, I _D = 20A V _{GS} = 10V, R _{GS} = 19Ω (Figures 15, 18, 19)	-	-	151	ns	
Turn-On Delay Time	t _{d(ON)}		-	7	-	ns	
Rise Time	t _r		-	93	-	ns	
Turn-Off Delay Time	t _{d(OFF)}		-	37	-	ns	
Fall Time	t _f		-	29	-	ns	
Turn-Off Time	t _{OFF}		-	-	100	ns	
GATE CHARGE SPECIFICATIONS							
Total Gate Charge at 10V	Q _{g(TOT)}	V _{GS} = 0V to 10V	V _{DD} = 10V, I _D = 20A, I _{g(REF)} = 1.0mA (Figures 13, 16, 17)	-	14.4	17	nC
Total Gate Charge at 5V	Q _{g(TOT)}	V _{GS} = 0V to 5V		-	7.8	9	nC
Threshold Gate Charge	Q _{g(TH)}	V _{GS} = 0V to 1V		-	0.9	1	nC
Gate to Source Gate Charge	Q _{gs}			-	3.5	-	nC
Gate to Drain “Miller” Charge	Q _{gd}			-	3.2	-	nC
CAPACITANCE SPECIFICATIONS							
Input Capacitance	C _{ISS}	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz (Figure 12)	-	624	-	pF	
Output Capacitance	C _{OSS}		-	444	-	pF	
Reverse Transfer Capacitance	C _{RSS}		-	71	-	pF	

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	V_{SD}	$I_{SD} = 20\text{A}$	-	-	1.25	V
		$I_{SD} = 10\text{A}$	-	-	1.0	V
Reverse Recovery Time	t_{rr}	$I_{SD} = 20\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	55	ns
Reverse Recovered Charge	Q_{RR}	$I_{SD} = 20\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	82	nC

Typical Performance Curves

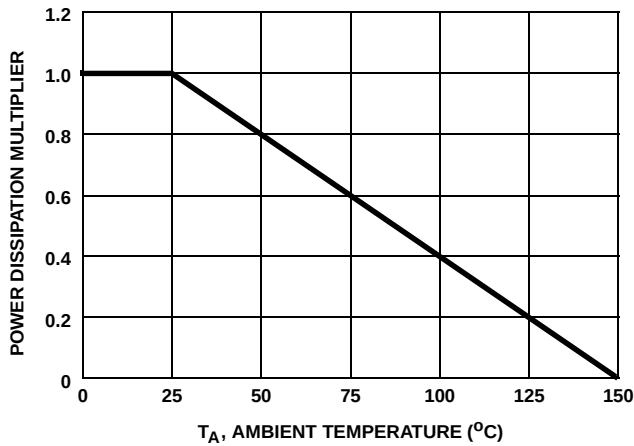


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

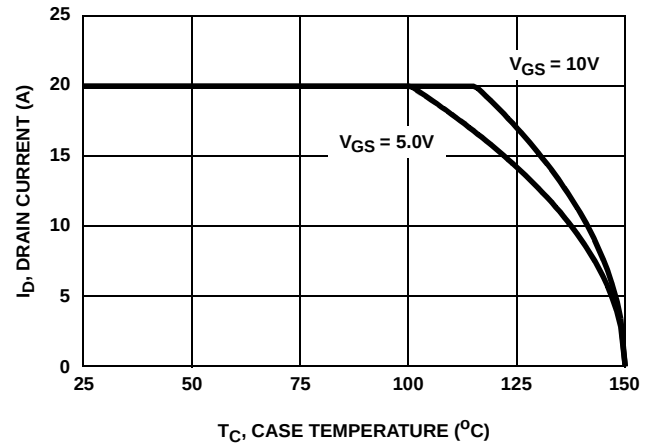


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

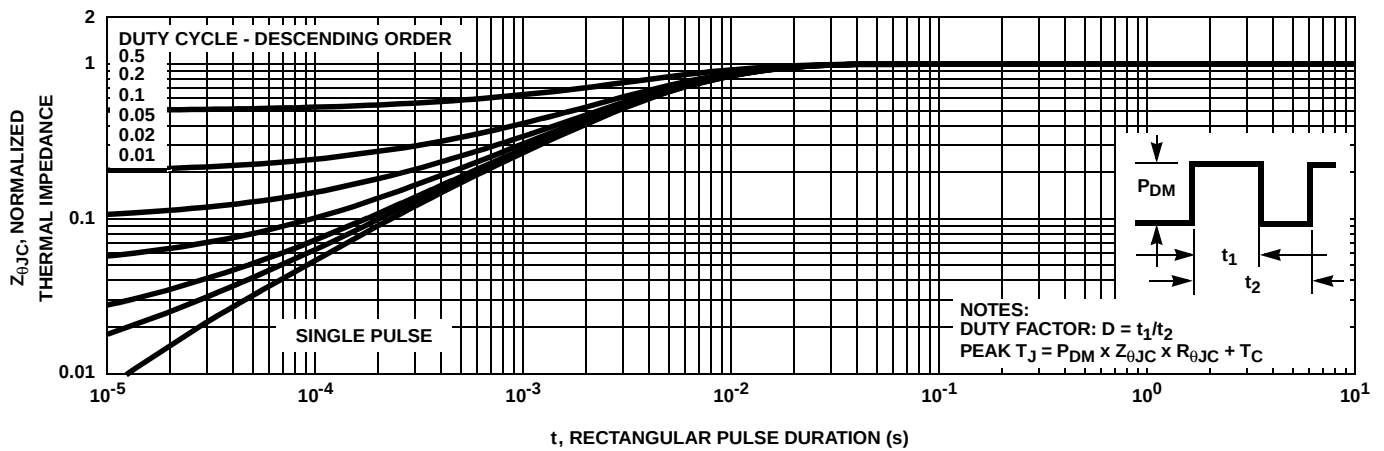


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

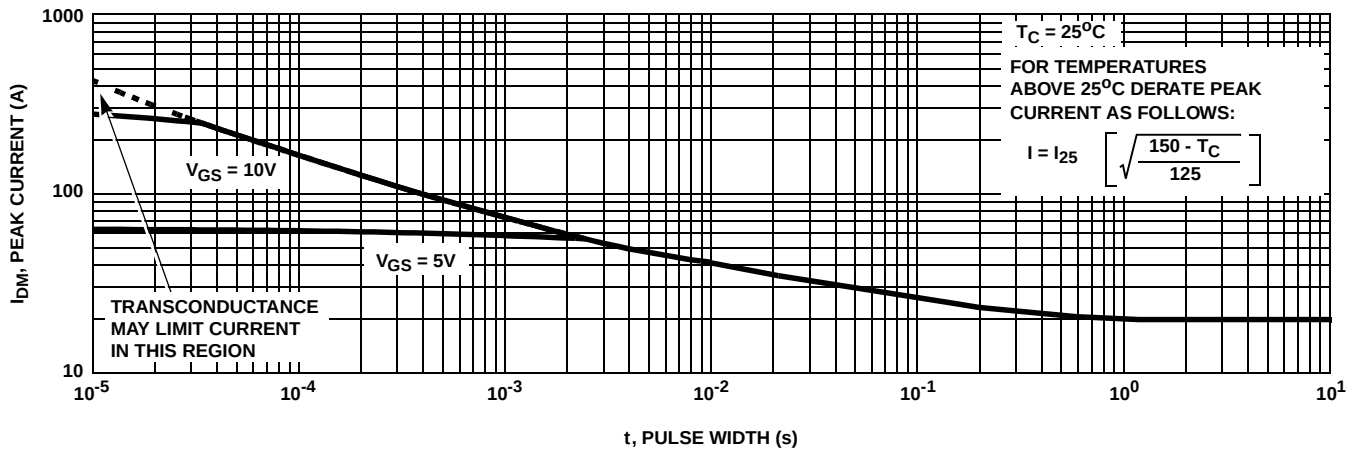


FIGURE 4. PEAK CURRENT CAPABILITY

Typical Performance Curves (Continued)

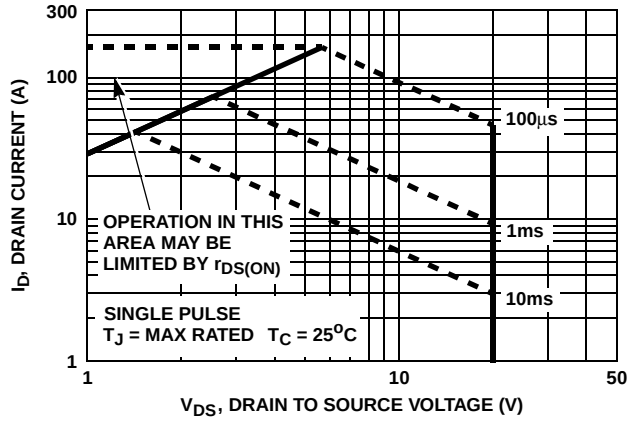


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

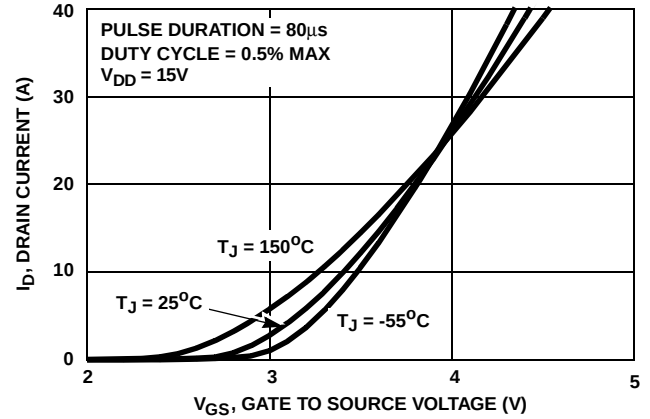


FIGURE 6. TRANSFER CHARACTERISTICS

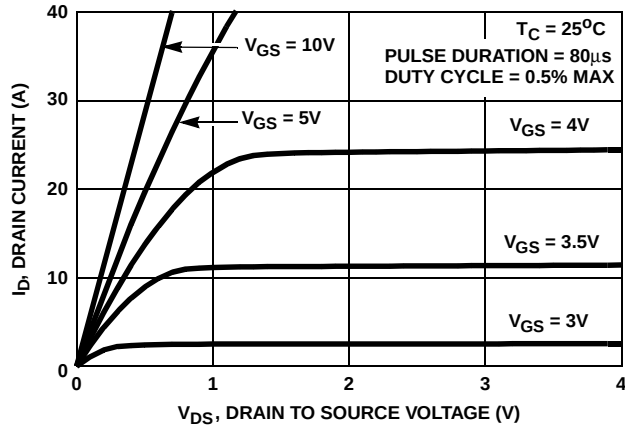


FIGURE 7. SATURATION CHARACTERISTICS

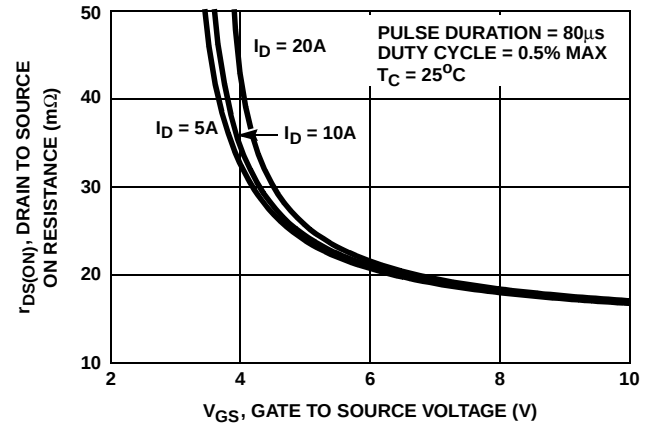


FIGURE 8. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT

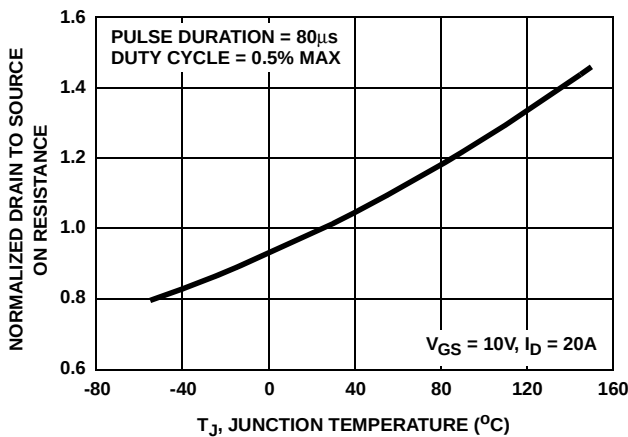


FIGURE 9. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

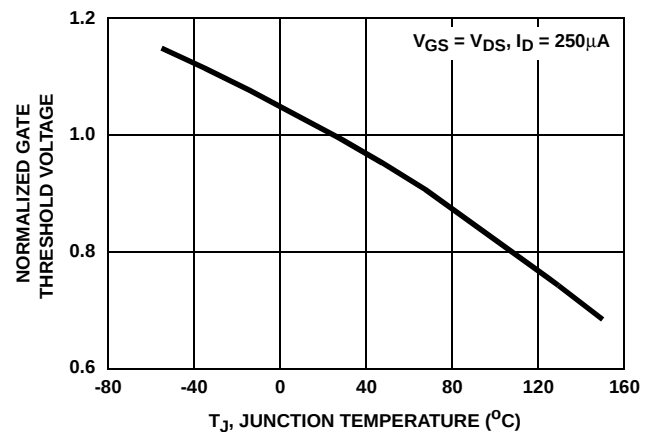


FIGURE 10. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

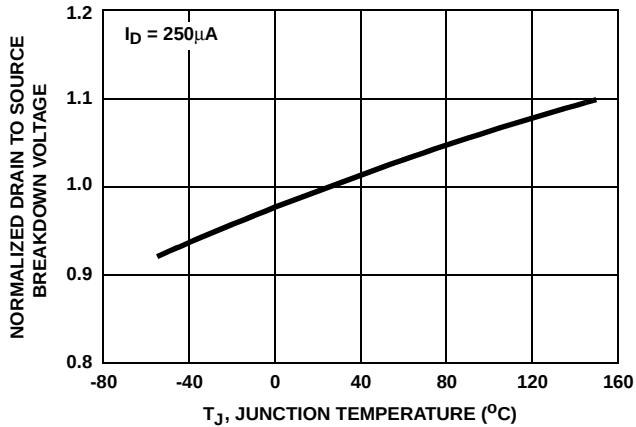


FIGURE 11. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

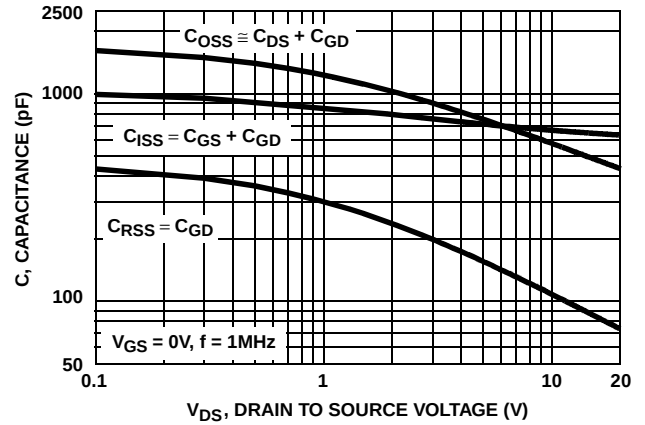
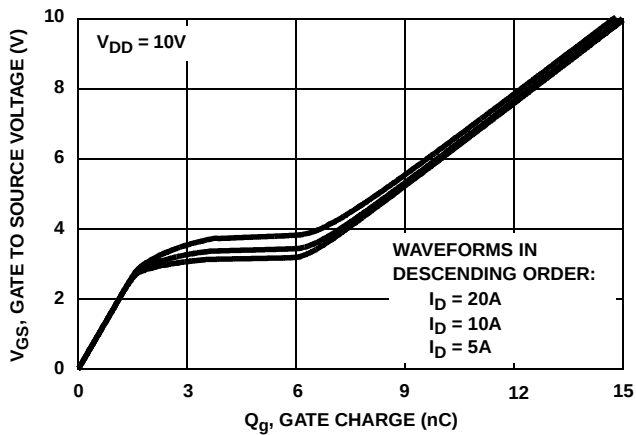


FIGURE 12. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE



NOTE: Refer to Fairchild Application Notes AN7254 and AN7260.

FIGURE 13. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

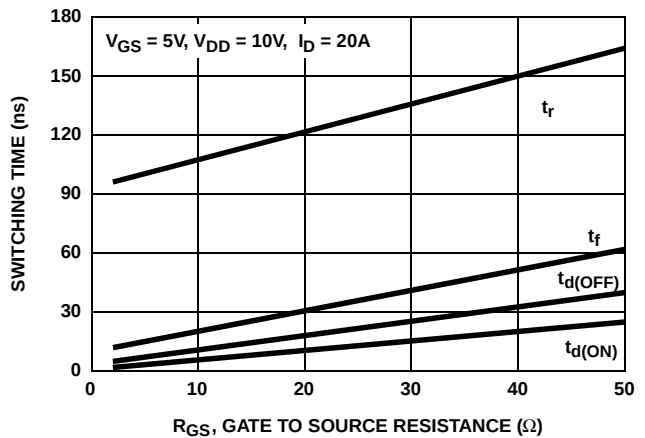


FIGURE 14. SWITCHING TIME vs GATE RESISTANCE

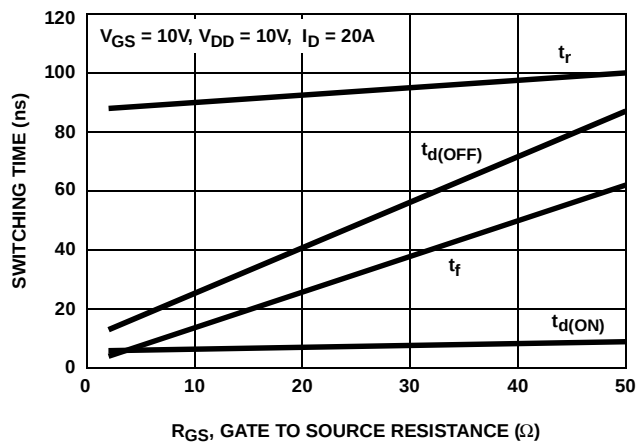


FIGURE 15. SWITCHING TIME vs GATE RESISTANCE

Test Circuits and Waveforms

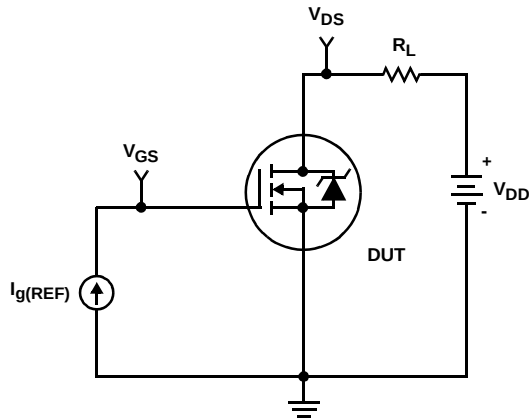


FIGURE 16. GATE CHARGE TEST CIRCUIT

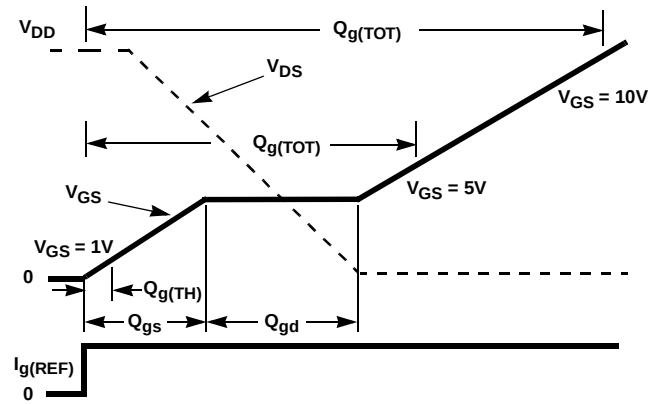


FIGURE 17. GATE CHARGE WAVEFORMS

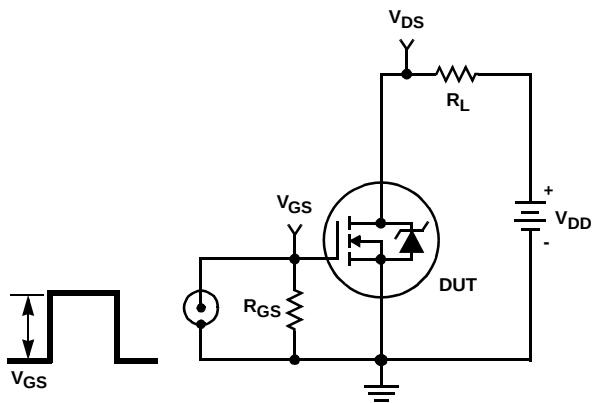


FIGURE 18. SWITCHING TIME TEST CIRCUIT

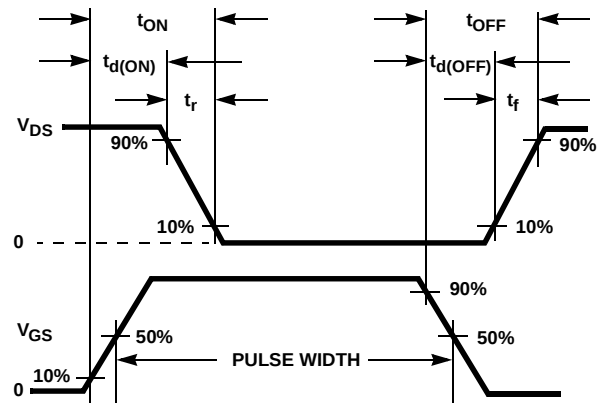


FIGURE 19. SWITCHING TIME WAVEFORM

HUF76013P3, HUF76013D3S

PSPICE Electrical Model

.SUBCKT HUF76013P3 2 1 3 ; rev 23March 2000

CA 12 8 6.5e-10
CB 15 14 7.0e-10
CIN 6 8 5.6e-10

DBODY 7 5 DBODYMOD
DBREAK 5 11 DBREAKMOD
DPLCAP 10 5 DPLCAPMOD

EBREAK 11 7 17 18 26
EDS 14 8 5 8 1
EGS 13 8 6 8 1
ESG 6 10 6 8 1
EVTHRES 6 21 19 8 1
EVTEMP 20 6 18 22 1

IT 8 17 1

LDRAIN 2 5 1.00e-9
LGATE 1 9 4.9e-9
LSOURCE 3 7 4.9e-9

MMED 16 6 8 8 MMEDMOD
MSTRO 16 6 8 8 MSTROMOD
MWEAK 16 21 8 8 MWEAKMOD

RBREAK 17 18 RBREAKMOD 1
RDRAIN 50 16 RDRAINMOD 1e-3
RGATE 9 20 3.0
RLDRAIN 2 5 10
RLGATE 1 9 49
RLSOURCE 3 7 49
RSLC1 5 51 RSLCMOD 1e-6
RSLC2 5 50 1e3
RSOURCE 8 7 RSOURCEMOD 12.5e-3
RVTHRES 22 8 RVTHRESMOD 1
RVTEMP 18 19 RVTEMPMOD 1

S1A 6 12 13 8 S1AMOD
S1B 13 12 13 8 S1BMOD
S2A 6 15 14 13 S2AMOD
S2B 13 15 14 13 S2BMOD

VBAT 22 19 DC 1

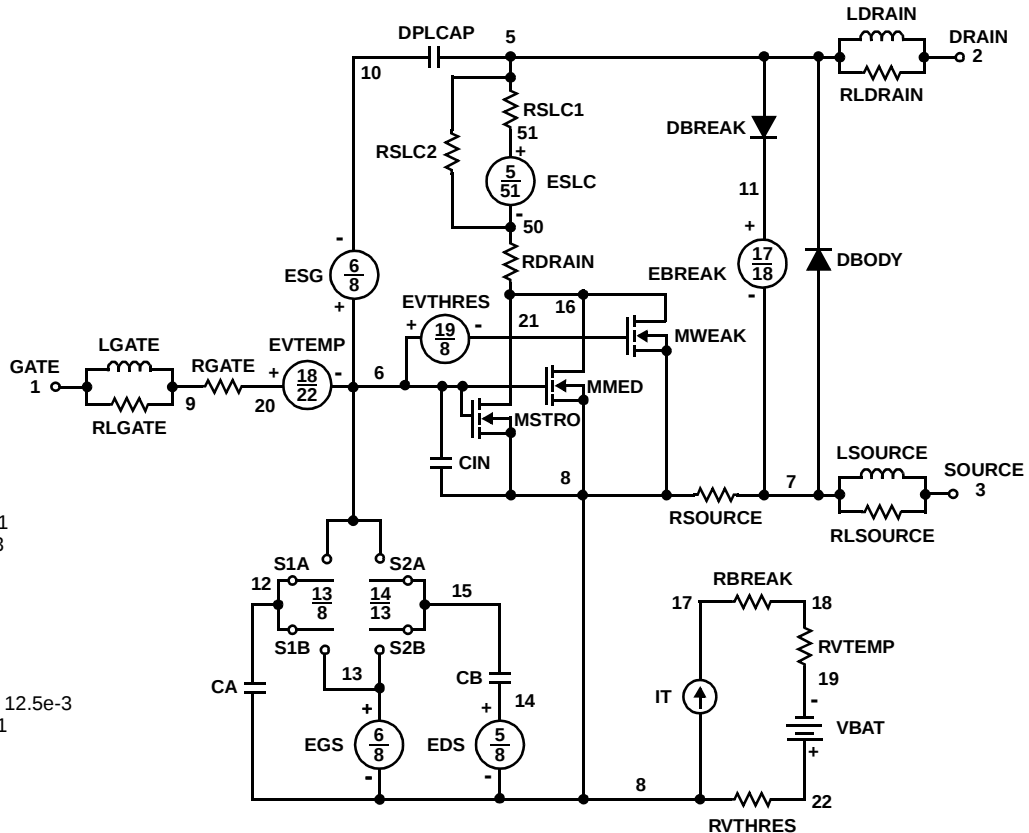
ESLC 51 50 VALUE={(V(5,51)/ABS(V(5,51)))*(PWR(V(5,51)/(1e-6*175),2.5))}

.MODEL DBODYMOD D (IS = 5.4e-13 RS = 1.15e-2 TRS1 = 7.0e-5 TRS2 = -1.0e-6 CJO = 12.3e-10 TT = 2.93e-8 M = 0.40)
.MODEL DBREAKMOD D (RS = 3.50e- 1TRS1 = 1e- 3TRS2 = -6.5e-6)
.MODEL DPLCAPMOD D (CJO = 4.6e-1 0IS = 1e-3 0N = 10 M = 0.6)
.MODEL MMEDMOD NMOS (VTO = 2.2 KP = 2.0 IS = 1e-30 N = 10 TOX = 1 L = 1u W = 1u RG = 3.0)
.MODEL MSTROMOD NMOS (VTO = 2.66 KP = 40 IS = 1e-30 N = 10 TOX = 1 L = 1u W = 1u LAMBDA=.01)
.MODEL MWEAKMOD NMOS (VTO = 1.90 KP = 0.03 IS = 1e-30 N = 10 TOX = 1 L = 1u W = 1u RG = 30 RS = 0.1)
.MODEL RBREAKMOD RES (TC1 = 1.0e- 3TC2 = -1.0e-6)
.MODEL RDRAINMOD RES (TC1 = 2.1e-2 TC2 = 6.5e-5)
.MODEL RSLCMOD RES (TC1 = 3.5e-3 TC2 = 2e-6)
.MODEL RSOURCEMOD RES (TC1 = 1e-3 TC2 = 1e-6)
.MODEL RVTHRESMOD RES (TC1 = -1.9e-3 TC2 = -6.0e-6)
.MODEL RVTEMPMOD RES (TC1 = -1.8e- 3TC2 = 0)

.MODEL S1AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -4.5 VOFF = -1.5)
.MODEL S1BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -1.5 VOFF = -4.5)
.MODEL S2AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -0.5 VOFF = 0)
.MODEL S2BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = 0 VOFF = -0.5)

.ENDS

NOTE: For further discussion of the PSPICE model, consult **A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options**; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.



SABER Electrical Model

REV 23March2000

template huf76013p3 n2,n1,n3

electrical n2,n1,n3

```
{
var i iscl
dp..model dbodymod = (isl = 5.4e-13, rs = 1.15e-2, trs1 = 7.0e-5, trs2 = -1e-6, cjo = 12.3e-10, tt = 2.93e-8, m = 0.40)
dp..model dbreakmod = (rs = 3.50e-1, trs1 = 1e-3, trs2 = -6.5e-6)
dp..model dplcapmod = (cjo = 4.60e-10, isl = 10e-30, nl=10, m = 0.6)
m..model mmedmod = (type=_n, vto = 2.2, kp = 2.0, is = 1e-30, tox = 1)
m..model mstrongmod = (type=_n, vto = 2.66, kp = 40, lamda=0.01, is = 1e-30, tox = 1)
m..model mweakmod = (type=_n, vto = 1.90, kp = 0.03, is = 1e-30, tox = 1, rs=0.1)
sw_vcsp..model s1amod = (ron = 1e-5, roff = 0.1, von = -4.5, voff = -1.5)
sw_vcsp..model s1bmod = (ron = 1e-5, roff = 0.1, von = -1.5, voff = -4.5)
sw_vcsp..model s2amod = (ron = 1e-5, roff = 0.1, von = -0.5, voff = 0)
sw_vcsp..model s2bmod = (ron = 1e-5, roff = 0.1, von = 0, voff = -0.5)
```

c.ca n12 n8 = 6.50e-10

c.cb n15 n14 = 7.0e-10

c.cin n6 n8 = 5.60e-10

dp.dbody n7 n5 = model=dbodymod

dp.dbreak n5 n11 = model=dbreakmod

dp.dplcap n10 n5 = model=dplcapmod

i.it n8 n17 = 1

l.ldrain n2 n5 = 1.00e-9

l.lgate n1 n9 = 4.9e-9

l.lsource n3 n7 = 4.9e-9

m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u

m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u

m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u

res.rbreak n17 n18 = 1, tc1 = 1.0e-3, tc2 = -1.00e-6

res.rdrain n50 n16 = 1e-3, tc1 = 2.1e-2, tc2 = 6.5e-5

res.rgate n9 n20 = 3.0

res.rldrain n2 n5 = 10

res.rlgate n1 n9 = 49

res.rlsource n3 n7 = 49

res.rslc1 n5 n51 = 1e-6, tc1 = 3.5e-3, tc2 = 2.0e-6

res.rslc2 n5 n50 = 1e3

res.rsource n8 n7 = 12.5e-3, tc1 = 1.0e-3, tc2 = 1e-6

res.rvtemp n18 n19 = 1, tc1 = -1.8e-3, tc2 = 0

res.rvthres n22 n8 = 1, tc1 = -1.9e-3, tc2 = -6.00e-6

spe.ebreak n11 n7 n17 n18 = 26

spe.eds n14 n8 n5 n8 = 1

spe.egs n13 n8 n6 n8 = 1

spe.esg n6 n10 n6 n8 = 1

spe.evtemp n20 n6 n18 n22 = 1

spe.evthres n6 n21 n19 n8 = 1

sw_vcsp.s1a n6 n12 n13 n8 = model=s1amod

sw_vcsp.s1b n13 n12 n13 n8 = model=s1bmod

sw_vcsp.s2a n6 n15 n14 n13 = model=s2amod

sw_vcsp.s2b n13 n15 n14 n13 = model=s2bmod

v.vbat n22 n19 = dc=1

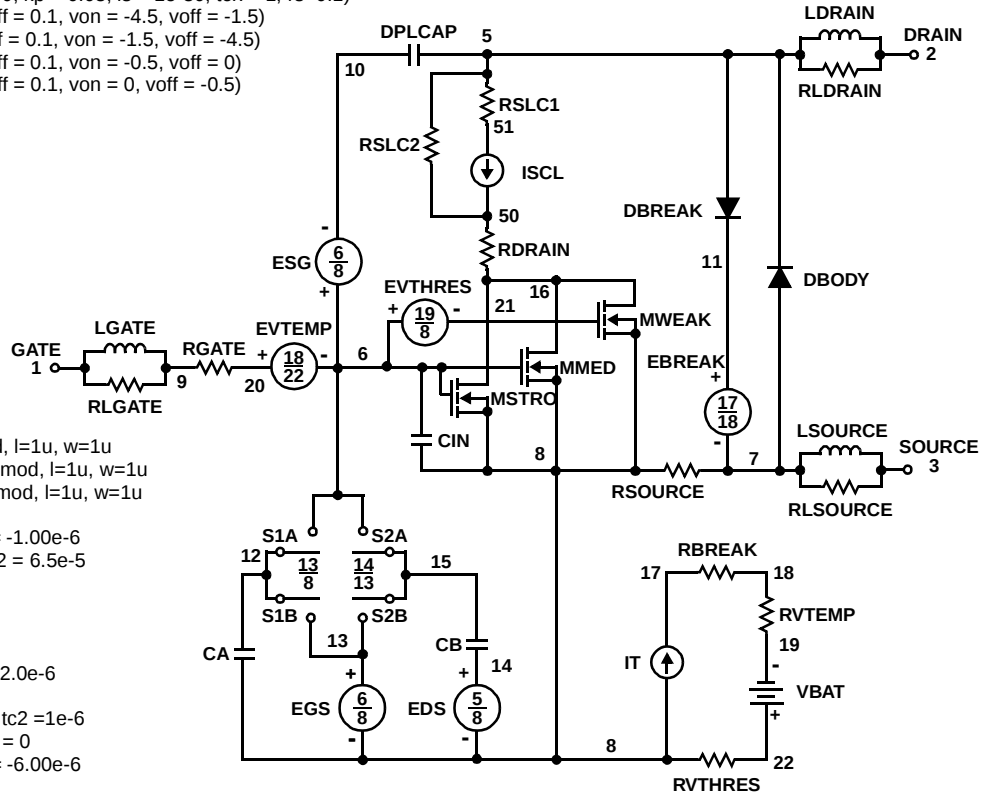
equations {

i (n51->n50) +=iscl

iscl: v(n51,n50) = (((v(n5,n51)/(1e-9+abs(v(n5,n51)))))*((abs(v(n5,n51)*1e6/175))** 2.5))

}

}



SPICE Thermal Model

REV 23March 2000

HUF76013T

CTHERM1 th 6 1.0e-3
 CHERM2 6 5 2.80e-3
 CHERM3 5 4 3.00e-3
 CHERM4 4 3 3.40e-3
 CHERM5 3 2 6.40e-3
 CHERM6 2 tl 9.50e-2

RHERM1 th 6 1.85e-2
 RHERM2 6 5 4.61e-2
 RHERM3 5 4 1.30e-1
 RHERM4 4 3 7.29e-1
 RHERM5 3 2 1.10
 RHERM6 2 tl 1.46e-1

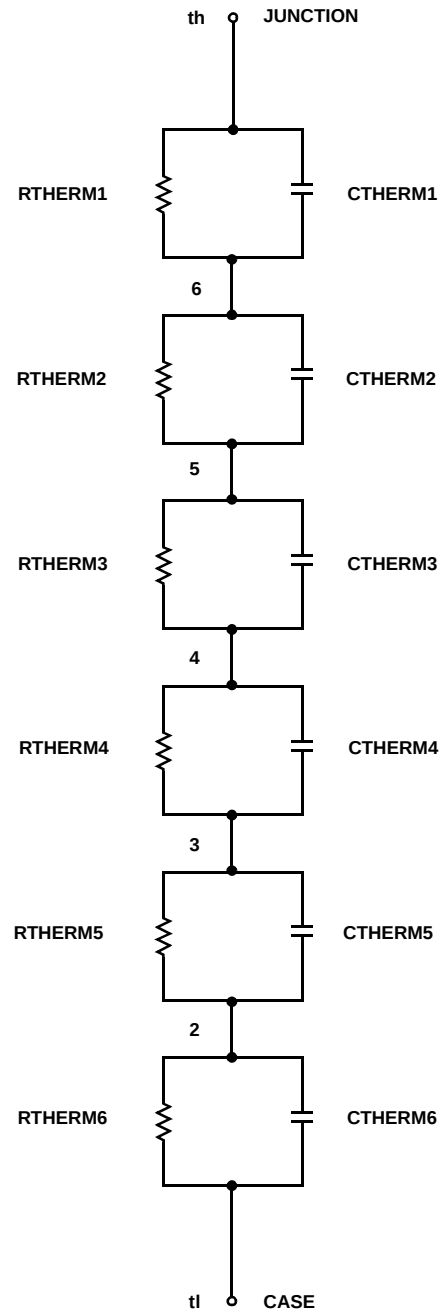
SABER Thermal Model

SABER thermal model HUF76013T

template thermal_model th tl
 thermal_c th, tl

```
{
    ctherm.therm1 th 6 = 1.0e-3
    ctherm.therm2 6 5 = 2.80e-3
    ctherm.therm3 5 4 = 3.00e-3
    ctherm.therm4 4 3 = 3.40e-3
    ctherm.therm5 3 2 = 6.40e-3
    ctherm.therm6 2 tl = 9.50e-2
```

```
    rtherm.rtherm1 th 6 = 1.85e-2
    rtherm.rtherm2 6 5 = 4.61e-2
    rtherm.rtherm3 5 4 = 1.30e-1
    rtherm.rtherm4 4 3 = 7.29e-1
    rtherm.rtherm5 3 2 = 1.10
    rtherm.rtherm6 2 tl = 1.46e-1
}
```



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Bottomless TM	FAST ^r TM	OPTOPLANAR TM	STAR*POWER TM	
CoolFET TM	FRFET TM	PACMAN TM	Stealth TM	
CROSSVOLT TM	GlobalOptoisolator TM	POP TM	SuperSOT TM -3	
DenseTrench TM	GTO TM	Power247 TM	SuperSOT TM -6	
DOME TM	HiSeC TM	PowerTrench [®]	SuperSOT TM -8	
EcoSPARK TM	ISOPLANAR TM	QFET TM	SyncFET TM	
E ² CMOS TM	LittleFET TM	QS TM	TinyLogic TM	
EnSigna TM	MicroFET TM	QT Optoelectronics TM	TruTranslation TM	
FACT TM	MicroPak TM	Quiet Series TM	UHC TM	
FACT Quiet Series TM	MICROWIRE TM	SILENT SWITCHER [®]	UltraFET [®]	

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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